

Harvatek Surface Mount LED Data Sheet HT-170IRPJ-XXXX

Official Product	Product: HT-170IRPJ-XXXX	Data Sheet No.		
Tentative Product	*****	HT-170IRPJ-XXXX		
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		August 20, 2009	Version of 1.0	Page 1/13

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DISCLAIMER

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HARVATEK's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of HARVATEK or HARVATEK INTERNATIONAL. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.

2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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Product Specifications

Product	Peak Wavelength	Test Current I _{FP} (mA) $t_P = 20ms$	Radiant Intensity (mW/Sr)	Forward Voltage V _F (V)	Orderable Part Number
HT-170IRPJ	850 nm	100	3.0 min 1.5 typ		HT-170IRPJ-XXXX
	Specification		Material	Quantity	
Resin	Water clear		Epoxy resin		
Carrier tape	Per EIA 481-1A spe	ecs	Transparent	4000 pcs per reel	
Reel	Per EIA 481-1A spe	ecs	Plastic / White		
Label	HT standard		Paper		
Packing bag	220x240mm		Aluminum laminated bag/ no-zipper		One reel per bag
Carton	HT standard		Paper		
	•		•		•

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Compliance and Certification

RoHS compliant and IS9002, QS9000 and ISO14001 certified.



ATTENTION: Electrostatic Discharge (ESD) protection



The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AIGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AIInGaP, GaN, or/and InGaN

based chips are **STATIC SENSITIVE devices**. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

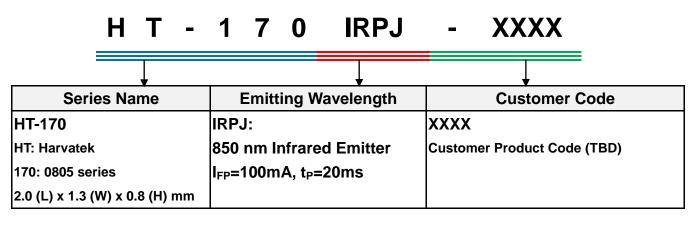
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Label Specifications

HARVATEK	Date:yyyy/mm/dd
CUSTOMER P/N:	
HARVATEK P/N:	 QTY: PCS
IV BIN: COLOR BIN:	QC

Harvatek P/N:



Lot P/N:

1	2	3	4	5	6	7	8	9	10
Ρ	1	2	2	3	0	Α	-	D	Т

Code 1	Code 2	Code 3	Code 4, 5	Code 6, 7	Code 9	Code 10
	Mfg. Year	Mfg. Month	Mfg. Date	Lots	Resin Color	Packaging
		1: Jan.				
	Z: 2000	2: Feb.				
Internal	1: 2001		1~31/ (30)	04 00	C: Clear D: Diffused	
Tracing	2: 2002	9: Sep.		01~99,		T: Tape & Reel
Code	3: 2003	A: Oct.		A,B,C		
		B: Nov.				
		C: Dec.				

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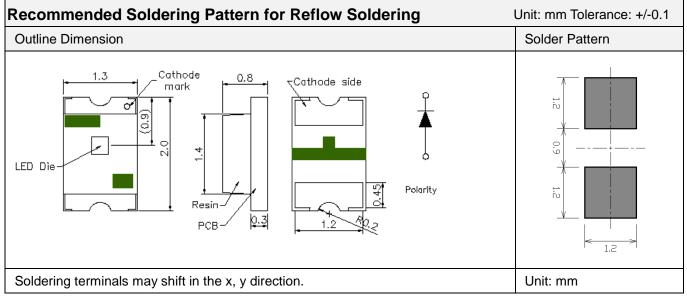
Product Features

Absolute Maximum Rating

Parameter	Symbol	Max.	Unit
Power Dissipation	PD	190	mW
Continuous Forward Current	١ _F	100	mA
Reverse Voltage	V _R	5	V
Operating Temperature	T _{OP}	-30 to 80	°C
Storage Temperature	T _{ST}	-40 to 85	°C

* @ t_P = 10 µs, duty cycle = 1%

Package Outline Dimension

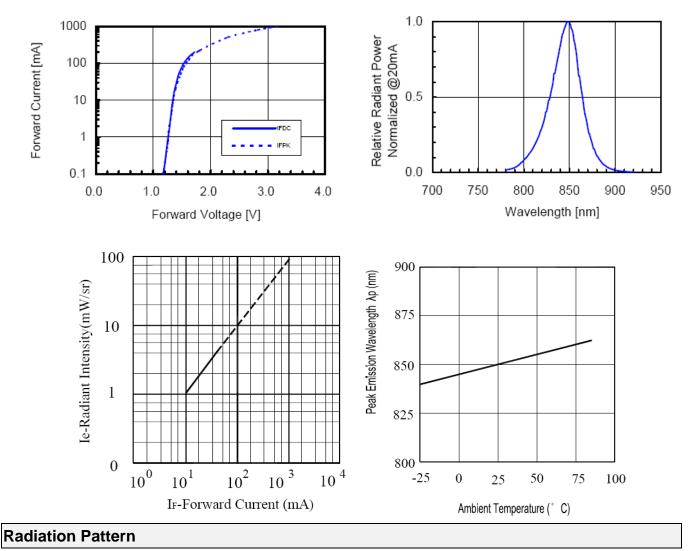


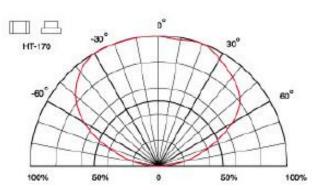
Electro-Optical Characteristics								
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition		
Forward Voltage	V _F	Ι	1.5	1.9	V	I _F =20mA		
Reverse Current	I _R	-	-	10	uA	V _R =5V		
Peak Emission Wavelength	λ _P	-	850	-	nm	I _F =20mA		
Padiant Intensity	l _e	3.0	7.0		mW/sr	I _{FP} =100mA		
Radiant Intensity		3.0		_		t _P =20ms		
Spectral Wavelength	Δλ	_	50	_	nm	I _F =20mA		
Emission Angle	2½θ	_	140	_	degrees	_		

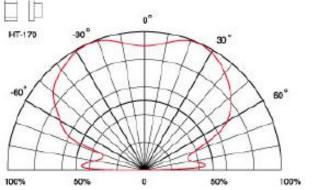
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Top Emitting Infrared Diode (0805) HT-170IRPJ-XXXX

Characteristics Curves



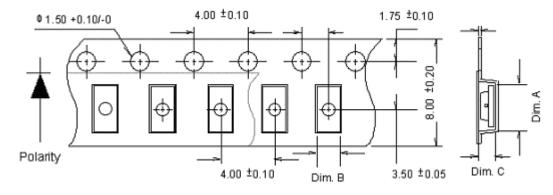




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Packaging

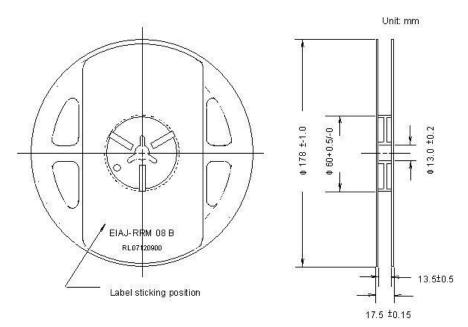
Tape Dimension



Part No.	Dim. A	Dim. B	Dim. C	Q'ty/Reel
HT-170IRPJ-XXXX	2.30±0.10	1.45±0.10	0.95±0.10	4K

Unit: mm

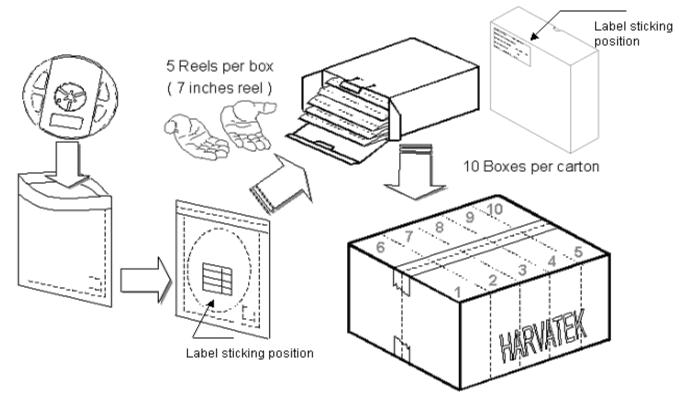
Reel Dimension



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Packing



5 boxes per carton is available depending on shipment quantity.

	Specification	Material	Quantity			
Carrier tape	Per EIA 481-1A specs	Transparent	4000 pcs per reel			
Reel	Per EIA 481-1A specs	Plastic / White				
Label	HT standard	Paper				
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag			
Carton	HT standard	Paper	Non-specified			
Others:						
Each immediate	Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin					
combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a						
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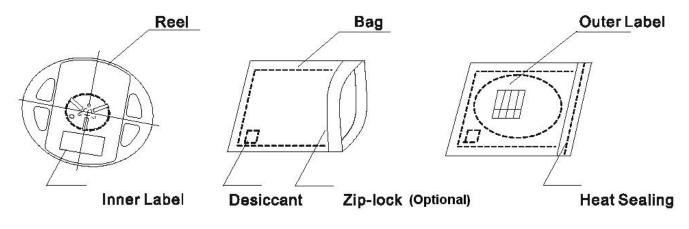
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Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



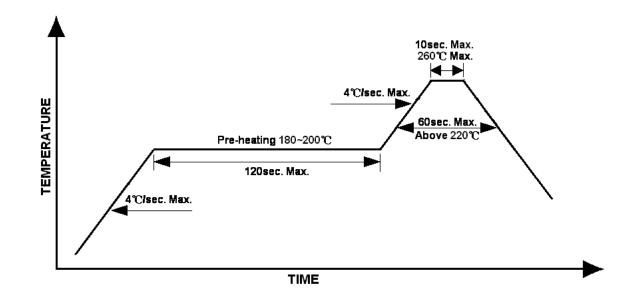
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Lead-free Solder Profile

Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 ^oC
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):



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Precautions

- 1. Avoid exposure to moisture at all times during transportation or storage.
- 2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
- 3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
- 4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
- 5. Avoid direct contact with the surface through which the LED emits light.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume < 1liter
- Curing: 100 ^OC max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

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